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Intended as reference data for China RoHS label creation, to be combined with English/Chinese form Specific P/N's should be substituted for part series on actual labels

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O: Indicates this hazardous substance in all homogeneous materials for this part is below limit requirement in SJ/T11363-2006

X: Indicates this hazardous substance contained in at least one homogeneous material for this part is above limit requirement in SJ/T11363-2006 Toxic or Hazardous Substances and Elements

Part series (look for LF versus non-LF entries)	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr(VI))	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)	Technical explanation for "X" marks	Environment- Friendly Use Period (EFUP, in years)	3rd Party Analysis available? (Y/N)
Trimmers 22LF	Х	0	0	0	0	0	Pb in electronic ceramic	TBD	N
23	X	Ö	X	Ö	Ö	Ö	Cd in thick film. Pb in electronic ceramic	TBD	N
23LF	Χ	0	0	0	O	0	Pb in electronic ceramic	TBD	N
24	Х	0	0	0	0	Ο	Pb in SnPb plated leads & electronic ceramic	TBD	N
24LF	Х	0	0	0	0	0	Pb in electronic ceramic	TBD	N
25	X	0	X	0	0	0	Cd in thick film. Pb in SnPb plated leads & electronic ceramic	TBD	N
25LF 43LF	X X	0	0	0	0	0	Pb in electronic ceramic Pb in electronic ceramic & copper alloy	TBD TBD	N N
4321	^	O	O	O	O	O	(brass shaft)	100	14
44 or 45	Х	0	0	0	0	0	Pb in SnPb plated leads & electronic ceramic & copper alloy (brass shaft)	TBD	N
44LF or 45LF	Х	0	0	0	0	0	Pb in electronic ceramic & copper alloy (brass shaft)	TBD	N
62	X	0	0	0	0	0	Pb in SnPb plated leads & electronic ceramic	TBD	N
62LF	X	0	0	0	0	0	Pb in electronic ceramic	TBD TBD	N N
66, 67, or 68	^	O	U	O	O	O	Pb in SnPb plated leads & electronic ceramic & copper alloy (brass shaft)	טפו	IN
66LF, 67LF, or 68LF	X	0	0	0	0	0	Pb in electronic ceramic & copper alloy (brass shaft)	TBD	N
72	Χ	0	0	0	0	0	Pb in SnPb plated leads & electronic ceramic	TBD	N
72LF	X	0	0	0	0	0	Pb in electronic ceramic	TBD	N
78	Х	0	0	0	0	0	Pb in SnPb plated leads & electronic ceramic & copper alloy (brass shaft)	TBD	N
78LF	Х	0	0	0	0	0	Pb in electronic ceramic & copper alloy (brass shaft)	TBD	N
82 or 83	Х	0	0	0	0	0	Pb in SnPb plated leads & electronic ceramic	TBD	N
82LF or 83LF	X	0	0	0	0	0	Pb in electronic ceramic	TBD	N
84 or 89	X	0	0	0	0	0	Pb in SnPb plated leads & electronic ceramic & copper alloy (brass shaft)	TBD	N
84LF or 89LF	X	0	0	0	0	0	Pb in electronic ceramic & copper alloy (brass shaft)	TBD	N
91 & 93	Х	0	0	0	0	0	Pb in SnPb plated leads & electronic ceramic	TBD	N
91LF, & 93LF	Х	0	0	0	0	0	Pb in electronic ceramic	TBD	N
Thin Film Networks All non-LF 66x, 68x, 69x, NQS, SQS, SSx, SPD	Х	0	0	0	0	0	Pb in SnPb leadframe plating	TBD	N
All with LF option	0	0	0	0	0	0		TBD	N
Precision Pots Non-LF 338x or 618x	Х	0	0	0	0	0	Pb in SnPb terminal plating & copper alloy	TBD	N
LE versione of 2000 or C10v	V	0	0	0	0	0	(brass)	TDD	N
LF versions of 338x or 618x	X	0	0	0	0	0	Pb in copper alloy (brass)	TBD	N
All versions of 51xx, 53xx, 54xx, 54xx, 56xx, 57xx, 61xx, 62xx, 63xx	Х	0	0	0	0	0	Pb in copper alloy (brass)	TBD	N
All versions of A, B, C, 72xx, 73xx, 74xx, 76xx, 81xx	Х	0	0	0	0	0	Pb in copper alloy (brass)	TBD	N
Non-LF linear pots 404, 424, 434, 474, 484	Χ	0	0	0	0	0	Pb in SnPb terminal plating, solder joints, & copper alloy (brass)	TBD	N
LF versions of 404, 424, 434, 474, 484	X	0	0	0	0	0	Pb in copper alloy (brass)	TBD	N
Thick Film Networks									
Non-LF BB	X	0	0	0	0	0	Pb in solder and electronic ceramic	TBD	N
LF version BB	X	0	0	0	0	0	Pb in electronic ceramic	TBD	N
LF version BCN	X	0	0	0	0	0	Pb in electronic ceramic	TBD	N
LF version BH	X	0	0	0	0	0	Pb in glass section of thick film	TBD TBD	N
LF version C Non-LF L	X	0	0	0	0	0	Pb in glass section of thick film Pb in solder and glass section of thick film		N N
LF version L	X	0	0	0	0	0	Pb in glass section of thick film	TBD TBD	N N
LF version M	X	0	0	0	0	0	Pb in glass section of thick film	TBD	N
LF version 62x	X	0	0	0	Ö	Ó	Pb in electronic ceramic, high melting point solder & copper leadframe	TBD	N
LF version 88x/89x	X	0	0	0	0	0	Pb in electronic ceramic, high melting point solder & copper leadframe	TBD	N

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Integrated Resistor/Capacit		0	•	0	0	0	Distriction of the office	TDD	N.
LF version CR	Х	0	0	0	0	0	Pb in glass section of thick film	TBD	N
LF version RC	Х	0	0	0	0	0	Pb in electronic ceramic	TBD	N
Diode Arrays									
LF version D	X	0	0	0	0	0	Pb in glass section of thick film	TBD	N
Power/Surge Resistors									
LF version BHV	X	0	0	0	0	0	Pb in electronic ceramic	TBD	N
LF version BHP	Χ	0	0	0	0	0	Pb in electronic ceramic	TBD	N
LF version BPC	Χ	0	0	0	0	0	Pb in electronic ceramic	TBD	N
LF version BPR	Χ	0	0	0	0	0	Pb in electronic ceramic	TBD	N
LF version BSR	Χ	0	0	0	0	0	Pb in electronic ceramic	TBD	N
LF version MHP	X	0	0	0	0	0	Pb in electronic ceramic	TBD	N